

TRADEMARK ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	SECURITY INTEREST		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
EPAC Technologies, Inc.		07/14/2010	CORPORATION: DELAWARE
RECEIVING PARTY DATA			
Name:	Silicon Valley Bank		
Street Address:	One Newton Executive Park		
Internal Address:	2221 Washington Street, Suite 200		
City:	Newton		
State/Country:	MASSACHUSETTS		
Postal Code:	02462		
Entity Type:	Bank: CALIFORNIA		
PROPERTY NUMBERS Total: 6			
Property Type	Number	Word Mark	
Registration Number:	2498719	SIGMATRIX	
Registration Number:	2607846	EPAC	
Registration Number:	2980078	ADVANCED PRINTING AND LOGISTICS	
Registration Number:	2914365		
Serial Number:	78842666	FLY FLOW FOLDER	
Serial Number:	78865899	DYNAMIC SUPPLY CHAIN	
CORRESPONDENCE DATA			
Fax Number:	(703)415-1557		
	<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>		
Phone:	703-415-1555		
Email:	mail@specializedpatent.com		
Correspondent Name:	Christopher E. Kondracki		
Address Line 1:	1725 Duke Street		
Address Line 2:	Suite 625		
Address Line 4:	Alexandria, VIRGINIA 22314		

CH \$165.00 2498719

900168662

TRADEMARK
REEL: 004254 FRAME: 0775

ATTORNEY DOCKET NUMBER:	1007808TM
NAME OF SUBMITTER:	Christopher E. Kondracki
Signature:	/Christopher E. Kondracki/
Date:	08/04/2010
Total Attachments: 8 source=EPAC#page1.tif source=EPAC#page2.tif source=EPAC#page3.tif source=EPAC#page4.tif source=EPAC#page5.tif source=EPAC#page6.tif source=EPAC#page7.tif source=EPAC#page8.tif	

INTELLECTUAL PROPERTY SECURITY AGREEMENT

This Intellectual Property Security Agreement is entered into as of July 14, 2010 by and between **SILICON VALLEY BANK** (“**Bank**”) and **EPAC TECHNOLOGIES, INC.** (“**Grantor**”).

RECITALS

A. Bank has agreed to make certain advances of money and to extend certain financial accommodation to Grantor (the “**Loans**”) in the amounts and manner set forth in that certain Loan and Security Agreement by and between Bank and Grantor dated as of the date hereof (as the same may be amended, modified or supplemented from time to time, the “**Loan Agreement**”; capitalized terms used herein are used as defined in the Loan Agreement). Bank is willing to make the Loans to Grantor, but only upon the condition, among others, that Grantor shall grant to Bank a security interest in certain Copyrights, Trademarks, Patents, and Mask Works (as each term is described below) to secure the obligations of Grantor under the Loan Agreement.

B. Pursuant to the terms of the Loan Agreement, Grantor has granted to Bank a security interest in all of Grantor's right, title and interest, whether presently existing or hereafter acquired, in, to and under all of the Collateral.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, and intending to be legally bound, as collateral security for the prompt and complete payment when due of its obligations under the Loan Agreement, Grantor hereby represents, warrants, covenants and agrees as follows:

AGREEMENT

To secure its obligations under the Loan Agreement, Grantor grants and pledges to Bank a security interest in all of Grantor's right, title and interest in, to and under its intellectual property (all of which shall collectively be called the “**Intellectual Property Collateral**”), including, without limitation, the following:

1. Any and all copyright rights, copyright applications, copyright registrations and like protections in each work or authorship and derivative work thereof, whether published or unpublished and whether or not the same also constitutes a trade secret, now or hereafter existing, created, acquired or held, including without limitation those set forth on Exhibit A attached hereto (collectively, the “**Copyrights**”);

2. Any and all trade secrets, and any and all intellectual property rights in computer software and computer software products now or hereafter existing, created, acquired or held;

3. Any and all design rights that may be available to Grantor now or hereafter existing, created, acquired or held;

4. All patents, patent applications and like protections including, without limitation, improvements, divisions, continuations, renewals, reissues, extensions and continuations-in-part of the

same, including without limitation the patents and patent applications set forth on Exhibit B attached hereto (collectively, the “**Patents**”);

5. Any trademark and servicemark rights, whether registered or not, applications to register and registrations of the same and like protections, and the entire goodwill of the business of Grantor connected with and symbolized by such trademarks, including without limitation those set forth on Exhibit C attached hereto (collectively, the “**Trademarks**”);

6. All mask works or similar rights available for the protection of semiconductor chips, now owned or hereafter acquired, including, without limitation those set forth on Exhibit D attached hereto (collectively, the “**Mask Works**”);

7. Any and all claims for damages by way of past, present and future infringements of any of the rights included above, with the right, but not the obligation, to sue for and collect such damages for said use or infringement of the intellectual property rights identified above;

8. All licenses or other rights to use any of the Copyrights, Patents, Trademarks, or Mask Works and all license fees and royalties arising from such use to the extent permitted by such license or rights;

9. All amendments, extensions, renewals and extensions of any of the Copyrights, Trademarks, Patents, or Mask Works; and

10. All proceeds and products of the foregoing, including without limitation all payments under insurance or any indemnity or warranty payable in respect of any of the foregoing.

This security interest is granted in conjunction with the security interest granted to Bank under the Loan Agreement. The rights and remedies of Bank with respect to the security interest granted hereby are in addition to those set forth in the Loan Agreement and the other Loan Documents, and those which are now or hereafter available to Bank as a matter of law or equity. Each right, power and remedy of Bank provided for herein or in the Loan Agreement or any of the Loan Documents, or now or hereafter existing at law or in equity shall be cumulative and concurrent and shall be in addition to every right, power or remedy provided for herein and the exercise by Bank of any one or more of the rights, powers or remedies provided for in this Intellectual Property Security Agreement, the Loan Agreement or any of the other Loan Documents, or now or hereafter existing at law or in equity, shall not preclude the simultaneous or later exercise by any person, including Bank, of any or all other rights, powers or remedies.

[Signature page follows.]

IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed by its officers thereunto duly authorized as of the first date written above.

GRANTOR:

Address of Grantor:

EPAC TECHNOLOGIES, INC

2561 Grant Ave.
San Leandro, California 94579
Attn: Mr. Dennis Morgan
Fax: [~~510-317-7993~~ 510-317-7993]
E-mail: dennism@epac.com

By: *Dennis Morgan*
Name: Dennis Morgan
Title: C.F.O.

BANK:

Address of Bank:

SILICON VALLEY BANK

One Newton Executive Park, Suite 200
2221 Washington Street
Newton, Massachusetts 02462
Attn: Mr. Jay Tracy
Fax: (617) 969-4395
E-mail: jtracy@svb.com

By: *Jay Tracy*
Name: Jay Tracy
Title: Relationship Manager

[Signature page to Intellectual Property Security Agreement]

EXHIBIT A

Copyrights

Description

Registration/
Application
Number

Registration/
Application
Date

NONE

EXHIBIT B

Patents

EPAC Patent Matters					
IMATTERNO	COUNTRY	SERIALNO	PATENTNO	TITLE	STATUS
356524.00500	UNITED STATES	10/914,681	7,503,555	SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	ISSUED
356524.00540.PC	WIPO	US05/27817		SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	NAT PHASE
356524.00541.AU	AUSTRALIA	2005274080		SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	PENDING
356524.00542.CA	CANADA	2,75795		A SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	PENDING
356524.00543.CN	CHINA	200580034101.X		SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	PUBLISHED
356524.00544.EP	EUROPEAN PATENT CONVENT	05782437.7		SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	PUBLISHED
356524.00545.JP	JAPAN	2007-525675		SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	PUBLISHED
356524.00546.MX	MEXICO	MX/a/2007/001542		SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	PENDING
356524.00547.RU	RUSSIAN FEDERATION	2007108548		SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	PENDING
356524.00548.ZA	SOUTH AFRICA	2007/01110	2007/01110	SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	ISSUED
356524.00549.KR	SOUTH KOREA	2007-7005323		SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	PENDING
356524.00550.BR	BRAZIL	PI 0514192-3		SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	PENDING
356524.00551.IN	INDIA	613/KOLNP/2007		SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	PENDING
356524.00552.IL	ISRAEL	181242		SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	PENDING
356524.00553.NZ	NEW ZEALAND	553090		SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	PUBLISHED
356524.00554.SG	SINGAPORE	200700922-8	129749 [WO/2006/020]	SYSTEM FOR AND A METHOD OF PRODUCING A BOOK ON DEMAND	ISSUED
356524.00600	UNITED STATES	11/175,676		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PUBLISHED
356524.00620.PC	WIPO	US06/25279		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	NAT PHASE

EPAC Patent Matters

IMATTERNO	COUNTRY	SERIALNO	PATENTNO	TITLE	STATUS
356524.00621.AU	AUSTRALIA	2006269526		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PENDING
356524.00622.CA	CANADA	2614305		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PENDING
356524.00623.CN	CHINA	200680032345.9		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PUBLISHED
356524.00624.JP	JAPAN	2008-520282		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PUBLISHED
356524.00625.KR	SOUTH KOREA	2008-7002664		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PENDING
356524.00626.IN	INDIA	87/KOLNP/2008		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PENDING
356524.00627.IL	ISRAEL	188605		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PENDING
356524.00628.MX	MEXICO	MA/a/2008/000326		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PENDING
356524.00629.NZ	NEW ZEALAND	565156		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PENDING
356524.00630.SG	SINGAPORE	200800035-8		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PENDING
356524.00631.RU	RUSSIAN FEDERATION	2008104424		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PENDING
356524.00632.ZA	SOUTH AFRICA	2008/00326		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PENDING
356524.00633.BR	BRAZIL	PI 0612401-1		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PENDING
356524.00634.ep	EUROPEAN PATENT CONVENT	06785799.5		A METHOD AND SYSTEM FOR PROCESSING PRINTED PRODUCTS	PUBLISHED
356524.00700	UNITED STATES	11/345,242		A METHOD AND SYSTEM FOR MANUFACTURING PRINTED PRODUCTS	PUBLISHED
356524.00720.PC	WIPO	PCT/US2007/000736		A METHOD AND SYSTEM FOR MANUFACTURING PRINTED PRODUCTS	PUBLISHED
356524.00721.CA	CANADA	2,637,259		A METHOD AND SYSTEM FOR MANUFACTURING PRINTED PRODUCTS	PENDING
356524.00722.JP	JAPAN	2008-553246		A METHOD AND SYSTEM FOR MANUFACTURING PRINTED PRODUCTS	PENDING
356524.00723.MX	MEXICO	MX/a/2008/009771		A METHOD AND SYSTEM FOR MANUFACTURING PRINTED PRODUCTS	PENDING
356524.00724.EP	EUROPEAN PATENT CONVENT	07716555.3		A METHOD AND SYSTEM FOR MANUFACTURING PRINTED PRODUCTS	PUBLISHED

EXHIBIT C

Trademarks

IMATTERNO	COUNTRYID	TMARK	APPNO	REGNO	STATUS
356524.00100	US	SIGMATRIX	75/624,946	2,498,719	REGISTERED
356524.00200	US	EPAC	75/720,809	2,607,846	REGISTERED
356524.00300	US	ADVANCED PRINTING & LOGISTICS	76/117,740	2,980,078	REGISTERED
356524.00400	US	WAVE DESIGN	76/564,165	2,914,365	REGISTERED
356524.00800	US	FLY FLOW FOLDER	78/842,666		No longer pursuing
356524.00900	US	DYNAMIC SUPPLY CHAIN	78/865,899		No longer pursuing

EXHIBIT D

Mask Works

Description

Registration/
Application
Number

Registration/
Application
Date

NONE

1222550.1